

4

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RELEASED FOR PUBLICATION

,1997

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LOC

DIST

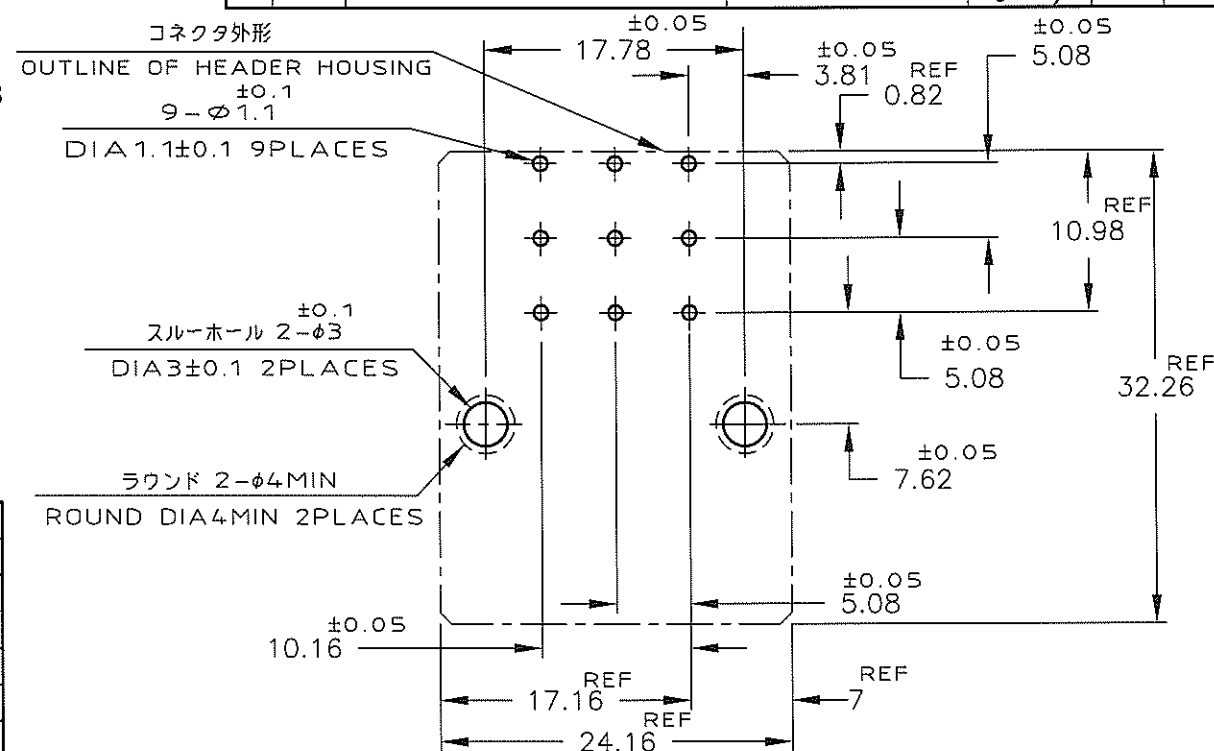
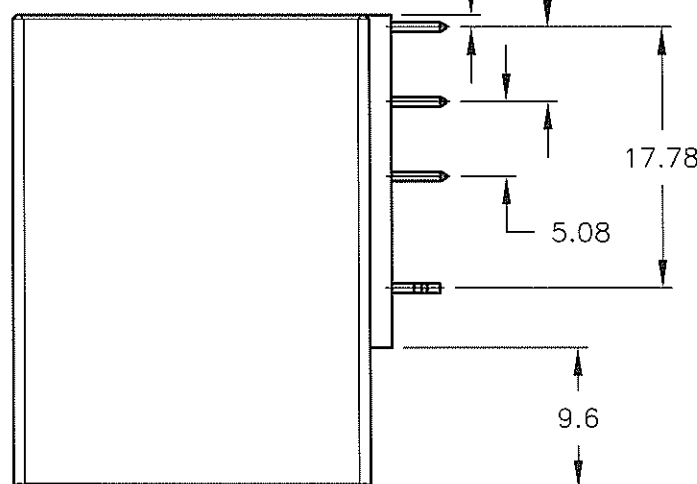
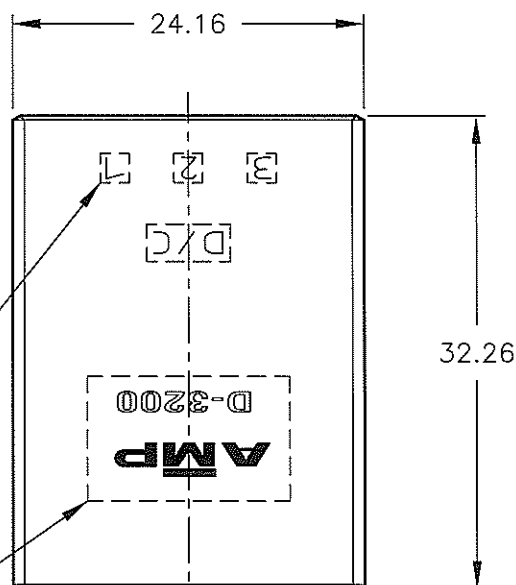
REVISIONS

変更

P	LTR	DESCRIPTION	ECN	DATE	DWN	APVD
	A	REVISED	FJ00-0875-98	16/JUN/98	KI	NM
	B	REVISED	FJD0-0114-03	25.APR/03	TS	SM
	C	REVISED	FJD0-0039-03	2JUN/03	TS	SM
	C1	REVISED	ECR-07-013273	11JUN/2007	TS	D.M

VIEW A  
回路番号  
CIRCUIT NO

AMPマーク  
シリーズマーク  
SERIES MARK



推奨基板取付け寸法  
PC 基板厚: 1.6±0.1  
(非累積公差)  
(コネクタ搭載面)

RECOMEND PC BOARD HOLE PATTERN  
PC BOARD THICKNESS: 1.6±0.1  
(NOT ACCUMULATE TOLERANCE)  
(CONNECTOR MOUNT SIDE)

注 記

1. 材料: ハウジング: ガラス入り熱可塑性

ポリエスチル樹脂

コンタクト: 銅合金

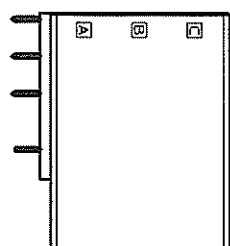
リテンションレグ: 銅合金

- △ めっき: コンタクト: 全面Ni下地  
接触部: 0.38μm MIN金めっき
- △ めっき: コンタクト: 全面Ni下地  
接触部: 2.0 μm MINスズめっき
- △ めっき: リテンションレグとコンタクト半田付部  
ニッケル下地の上に半田めっき
- △ めっき: リテンションレグとコンタクト半田付部  
ニッケル下地の上にスズめっき

## NOTES

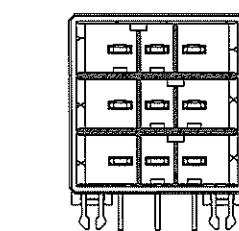
1. MATERIAL: HOUSING: GLASS FILLED THERMO  
PLASTIC, POLYESTER  
CONTACT: COPPER ALLOY  
RETENTION LEG: COPPER ALLOY

- △ FINISH (CONTACT AREA): 0.38μm MIN GOLD PLATING  
OVER Ni PLATING
- △ FINISH (CONTACT AREA): 2.0 μm MIN TIN  
PLATED OVER NICKEL
- △ FINISH (RETENTION LEG): TIN LEAD PLATED  
(CONTACT TAIL) OVER NICKEL
- △ FINISH (RETENTION LEG): TIN PLATED  
(CONTACT TAIL) OVER NICKEL

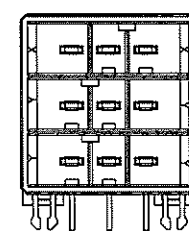


VIEW A  
(SCALE: 1:1)

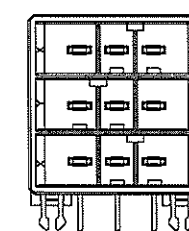
5	3	5-1123624-5	XYX
5	2	5-1123624-2	XYX
5	3	4-1123624-5	YYX
5	2	4-1123624-2	YYX
5	3	3-1123624-5	XXY
5	2	3-1123624-2	XXY
5	3	1-1123624-5	XXX
5	2	1-1123624-2	XXX
(FINISH)		製品番号 (PART NO.)	KEY



3-1123624-2, -5  
XXY KEY



4-1123624-2, -5  
YYX KEY



5-1123624-2, -5  
XYX KEY

THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN	16/MAR/'98
DIMENSIONS: 単位 寸 mm		CHK	K. IKEDA 16/MAR/'98
TOLERANCES UNLESS OTHERWISE SPECIFIED		APVD	N. MATSUBARA 16/MAR/'98
一般公差  10% ±0.3 3% >10 ±0.4 10% >30 ±0.4, 5 ANGLE ±3°		I. HASEGAWA PRODUCT SPEC 製品規格 108-5349 APPLICATION SPEC 取付適用規格 114-5148	
MATERIAL 材料	FINISH 仕上	WEIGHT	11.8g
SEE NOTE 注記参照	SEE NOTE 注記参照	CUSTOMER DRAWING	

WIRE RANGE 適合電線断面積		INSULATION DIA 絶縁外径	
8		8	
Tyco Electronics		Tyco Electronics AMP K.K. Kawasaki, Japan	
8		8	
NAME 名称		ダイナミック コネクター D3200T ヘッダーアセンブリー 9P (水平タイプ)	
		DYNAMIC CONN. D3200T HORIZONTAL HDR ASS'Y 9P	
SIZE	CAGE CODE	DRAWING NO 番号	RESTRICTED TO
A3	00779	C-1123624	-
SCALE 尺		SHEET	OF
2-1		7	7
		REV	C1

# Mouser Electronics

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[1-1123624-5](#)